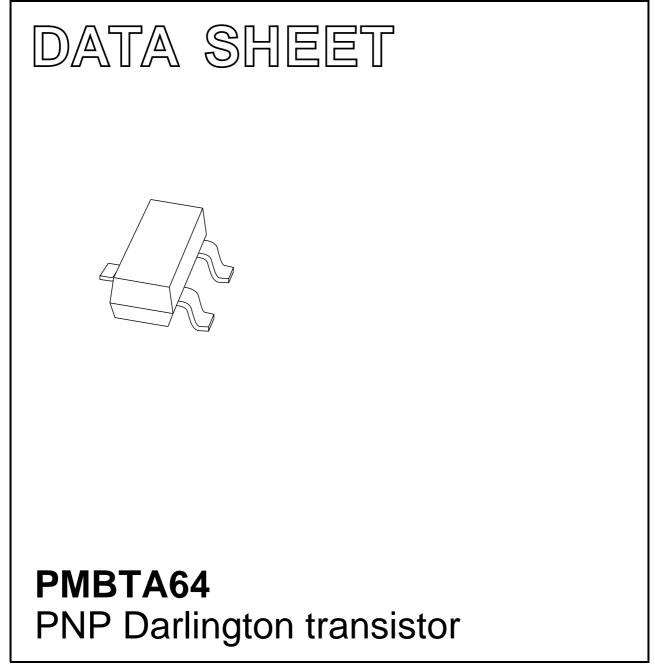
DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 2002 Nov 07 2004 Jan 22



Product data sheet

PNP Darlington transistor

FEATURES

- High current (max. 500 mA)
- Low voltage (max. 30 V)
- High DC current gain (min. 10000).

APPLICATIONS

• High input impedance preamplifiers.

DESCRIPTION

PNP Darlington transistor in a SOT23 plastic package. NPN complement: PMBTA14.

MARKING

TYPE NUMBER	MARKING CODE ⁽¹⁾		
PMBTA64	*2V		

Note

1. * = p : Made in Hong Kong.

* = t : Made in Malaysia.

* = W : Made in China.

ORDERING INFORMATION

TYPE PACKAGE NUMBER NAME DESCRIPTION VERSION PMBTA64 plastic surface mounted package; 3 leads SOT23

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-30	V
V _{CES}	collector-emitter voltage	V _{BE} = 0	_	-30	V
V _{EBO}	emitter-base voltage	open collector	_	-10	V
I _C	collector current (DC)		_	-500	mA
I _{CM}	peak collector current		_	-800	mA
I _B	base current (DC)		_	-200	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$; note 1	_	250	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

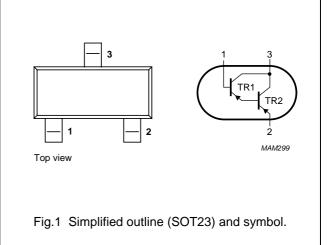
Note

1. Transistor mounted on an FR4 printed-circuit board.

PMBTA64

PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



PNP Darlington transistor

PMBTA64

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	500	K/W

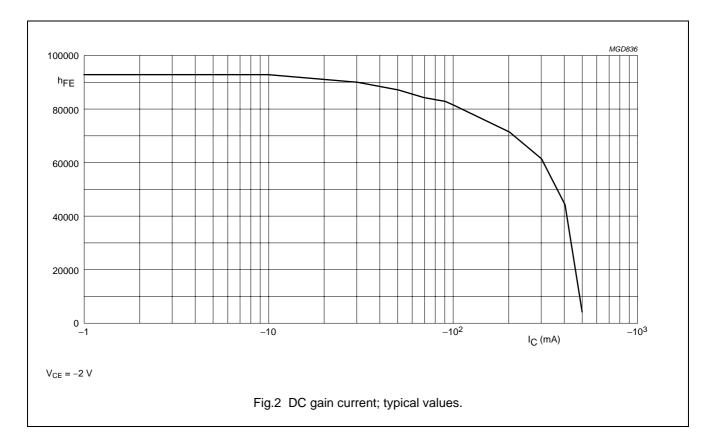
Note

1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

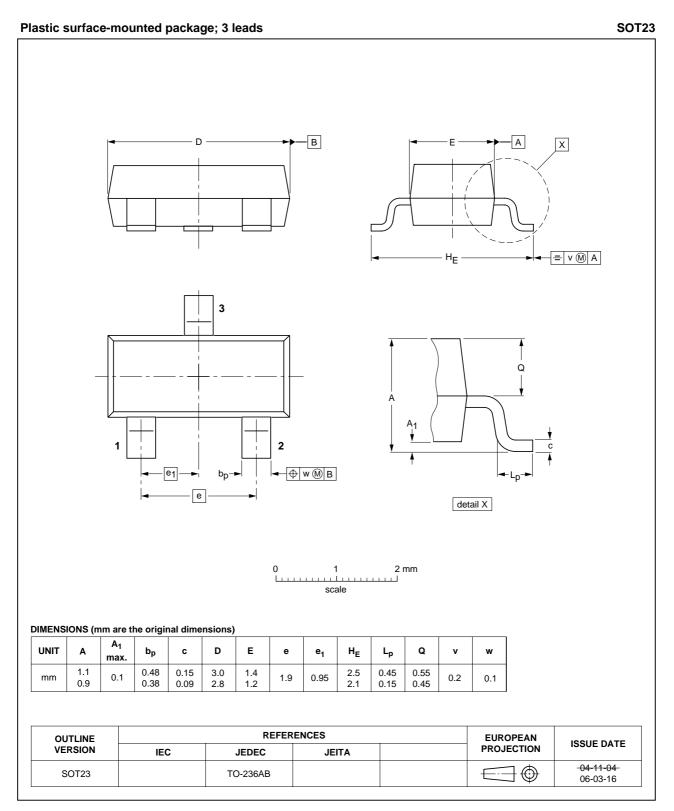
 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _{CBO}	collector cut-off current	$I_E = 0; V_{CB} = -30 V$	-	-100	nA
I _{EBO}	emitter cut-off current	$I_{C} = 0; V_{EB} = -10 V;$	-	-100	nA
h _{FE}	DC current gain	I_{C} = -10 mA; V_{CE} = -5 V; (see Fig.2)	10000	-	
		$I_{C} = -100 \text{ mA}; V_{CE} = -5 \text{ V}; \text{ (see Fig.2)}$	20000	-	
V _{CEsat}	collector-emitter saturation voltage	$I_{\rm C} = -100 \text{ mA}; I_{\rm B} = -0.1 \text{ mA}$	-	-1.5	V
V _{BEon}	base-emitter on-state voltage	$I_{C} = -100 \text{ mA}; V_{CE} = -5 \text{ V}$	_	-2	V
f _T	transition frequency	$I_{C} = -50 \text{ mA}; V_{CE} = -5 \text{ V}; f = 100 \text{ MHz}$	125	-	MHz



PNP Darlington transistor

PACKAGE OUTLINE



PMBTA64

PNP Darlington transistor

PMBTA64

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

- 1. Please consult the most recently issued document before initiating or completing a design.
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

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Printed in The Netherlands

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Date of release: 2004 Jan 22

Document order number: 9397 750 12525



R75/06/pp6